Authorized Representative*  Product-Env-Stewards  Product Enviro Compliance  Requester Item Number  Mfr Item Number  Mfr Item Name  Effective Date  Version  Manufacturing Site  Weight*  UOM  FDG6301N  SC88 25V DUAL N-FET 4 O  2021-02-03  CN1  5.759  mg  Manufacturing Proccess Information	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.					
Company name*  Company unique ID  Unique ID Authority  Response Date*  2021-02-03  Contact Name  Title - Contact  Product Enviro Compliance Authorized Representative*  Product-Env-Stewards  Product Enviro Compliance  NA  Product-Env-Stewards  Product Enviro Compliance  NA  Product-Env-Stewards  Product-Env-Stewards  Product Enviro Compliance  NA  Product-Env-Stewards  Pro						
In Semiconductor  In Semicondu						
Contact Name    Title - Contact   Phone - Contact*   Phone - Contact*   Product Enviro Compliance   NA   Product-Env-Stewards@onser						
Product-Env-Stewards Authorized Representative* Product-Env-Stewards Pro	2021-02-03					
Authorized Representative*  Product-Env-Stewards  Product Enviro Compliance  Requester Item Number  Mfr Item Number  Mfr Item Name  Effective Date  Version  Manufacturing Site  Weight*  UOM  FDG6301N  SC88 25V DUAL N-FET 4 O  2021-02-03  CN1  5.759  mg	Email - Contact*					
Product-Env-Stewards  Requester Item Number  Mfr Item Number  Mfr Item Name  Effective Date  Version  Manufacturing Site  Weight*  UOM  FDG6301N  SC88 25V DUAL N-FET 4 O  2021-02-03  CN1  5.759  mg	Product-Env-Stewards@onsemi.com					
Requester Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight* UOM FDG6301N SC88 25V DUAL N-FET 4 O 2021-02-03 CN1 5.759 mg  Manufacturing Proccess Information	Email - Representative*					
Requester Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight* UOM FDG6301N SC88 25V DUAL N-FET 4 O 2021-02-03 CN1 5.759 mg  Manufacturing Proccess Information	Product-Env-Stewards@onsemi.com					
Manufacturing Proccess Information	Unit Type					
	Each					
TO STANK STA						
Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow  Matter Tin (Sp.) appropriate CI Alloy 1. Seconds 1.	Cycles					
Matter Till (Sil) - aimeated CC Anoy I 200 C 30 Seconds 3						
omments						
vel 1 - maximum time at peak temperature during soldering is 10-30 seconds or more information regarding material composition please refer to page 3						

RoHS Material Composition Declaration			Declaration Type *	Detail	ed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DBP).									
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provid									
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted				
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the				

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.148	mg	Supplier	Silicon (Si)	7440-21-3		0.148	mg
Lead Frame	2.087		В	Nickel (Ni)	7440-02-0		0.7576	mg
			Supplier	Iron (Fe)	7439-89-6		1.0477	mg
			Supplier	Copper (Cu)	7440-50-8		0.2817	mg
Mold Compound-Black	3.224		Supplier	Boron zinc hydroxide oxide	138265-88-0		0.0967	mg
			Supplier	Zinc Monoxide (ZnO)	1314-13-2		0.0161	mg
			Supplier	2,4,6-triamino-1,3,5-triazine isocyanuric acid	37640-57-6		0.0967	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		2.418	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0161	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.4836	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0967	mg
Plating	0.274	mg	Supplier	Tin (Sn)	7440-31-5		0.274	mg
Wire Bond - Au	0.026	mg	Supplier	Gold (Au)	7440-57-5		0.026	mg